

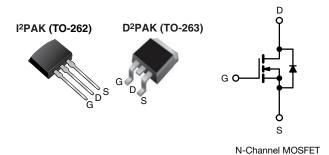
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HALOGEN FREE

# **Power MOSFET**

PRODUCT SUMMARY					
V <sub>DS</sub> (V)	500				
$R_{DS(on)}(\Omega)$	V <sub>GS</sub> = 10 V 1.5				
Q <sub>g</sub> max. (nC)	38				
Q <sub>gs</sub> (nC)	5.0				
Q <sub>gd</sub> (nC)	22				
Configuration	Single				



#### **FEATURES**

- Surface mount
- Available in tape and reel
- Dynamic dV/dt rating
- Repetitive avalanche rated
- · Fast switching
- Ease of paralleling
- Simple drive requirements
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

### **DESCRIPTION**

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The D<sup>2</sup>PAK (TO-263) is a surface mount power package capable of accommodating die size up to HEX-4. It provides the highest power capability and the lowest possible on-resistance in any existing surface mount package. The D<sup>2</sup>PAK (TO-263) is suitable for high current applications because of its low internal connection resistance and can dissipate up to 2.0 W in a typical surface mount application.

ORDERING INFORMATION						
Package	D <sup>2</sup> PAK (TO-263)	D <sup>2</sup> PAK (TO-263)	I <sup>2</sup> PAK (TO-262)			
Lead (Pb)-free and halogen-free	SiHF830S-GE3	SiHF830STRL-GE3 a	SiHF830L-GE3			
Lead (Pb)-free	IRF830SPbF	IRF830STRLPbF a	IRF830LPbF			

#### Note

a. See device orientation.

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			$V_{DS}$	500	V	
Gate-Source Voltage			$V_{GS}$	± 20	V	
Continuous Drain Current	V <sub>GS</sub> at 10 V	$T_{\rm C} = 25  ^{\circ}{\rm C}$ $T_{\rm C} = 100  ^{\circ}{\rm C}$	I=	4.5		
Continuous Drain Current	VGS at 10 V	T <sub>C</sub> = 100 °C	Ι <sub>D</sub>	2.9	Α	
Pulsed Drain Current <sup>a</sup>			$I_{DM}$	18		
Linear Derating Factor				0.59	W/°C	
Linear Derating Factor (PCB mount) e				0.025	VV/ C	
Single Pulse Avalanche Energy b			E <sub>AS</sub>	280	mJ	
Avalanche Current <sup>a</sup>			I <sub>AR</sub>	4.5	Α	
Repetitive Avalanche Energy <sup>a</sup>			E <sub>AR</sub>	7.4	mJ	
Maximum Power Dissipation $T_C = 25  ^{\circ}C$				74	w	
Maximum Power Dissipation (PCB mount) e T <sub>A</sub> = 25 °C			$P_{D}$	3.1	v	
Peak Diode Recovery dV/dt <sup>c</sup>			dV/dt	3.5	V/ns	
Operating Junction and Storage Temperature Range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Soldering Recommendations (Peak temperature) d	for	10 s		300		

- Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11). V<sub>DD</sub> = 50 V, starting T<sub>J</sub> = 25 °C, L = 24 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 4.5 A (see fig. 12). I<sub>SD</sub>  $\leq$  4.5 A, dI/dt  $\leq$  75 A/µs, V<sub>DD</sub>  $\leq$  V<sub>DS</sub>, T<sub>J</sub>  $\leq$  150 °C.

- 1.6 mm from case.
- When mounted on 1" square PCB (FR-4 or G-10 material).

# IRF830S, SiHF830S, IRF830L, SiHF830L

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THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	62			
Maximum Junction-to-Ambient (PCB mount) <sup>a</sup>	R <sub>thJA</sub>	-	40	°C/W		
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	1.7			

### Note

a. When mounted on 1" square PCB (FR-4 or G-10 material).

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static		•		L	L		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0$ , $I_{D} = 250 \mu A$		500	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	ce to 25 °C, I <sub>D</sub> = 1 mA	-	0.61	-	V/°C
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
Gate-Source Leakage	I <sub>GSS</sub>		V <sub>GS</sub> = ± 20 V	-	_	± 100	nA
Zawa Cata Valtana Duain Comment		V <sub>DS</sub> =	= 500 V, V <sub>GS</sub> = 0 V	-	-	25	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 400 \	/, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	250	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 2.7 A <sup>b</sup>	-	-	1.5	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	= 50 V, I <sub>D</sub> = 2.7 A <sup>b</sup>	2.5	-	-	S
Dynamic							
Input Capacitance	C <sub>iss</sub>		$V_{GS} = 0 V$ ,	-	610	-	
Output Capacitance	C <sub>oss</sub>		$V_{DS} = 25 \text{ V},$	=	160	-	рF
Reverse Transfer Capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	68	-	
Total Gate Charge	Qg			-	-	38	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$ $I_D = 3.1 \text{ A}, V_{DS} = 400 \text{ V},$ see fig. 6 and 13 <sup>b</sup>		=	-	5.0	nC
Gate-Drain Charge	Q <sub>gd</sub>		see lig. 6 and 13-		-	22	
Turn-On Delay Time	t <sub>d(on)</sub>			-	8.2	-	
Rise Time	t <sub>r</sub>	$V_{DD} = 250 \text{ V}, I_D = 3.1 \text{ A},$ $R_g = 12 \Omega, R_D = 79 \Omega, \text{ see fig. } 10^b$		=	16	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>			-	42	-	
Fall Time	t <sub>f</sub>			-	16	-	
Internal Drain Inductance	L <sub>D</sub>	Between lead, 6 mm (0.25") from		-	4.5	-	nl.l
Internal Source Inductance	L <sub>S</sub>	package and die contact	package and center of		7.5	-	- nH
Gate Input Resistance	$R_g$	f = 1 MHz, open drain		0.5	-	2.7	Ω
<b>Drain-Source Body Diode Characteristic</b>	es						
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the		-	-	4.5	^
Pulsed Diode Forward Current <sup>a</sup>	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	18	- A
Body Diode Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 4.5 A, V <sub>GS</sub> = 0 V <sup>b</sup>	-	-	1.6	V
Body Diode Reverse Recovery Time	t <sub>rr</sub>			-	320	640	ns
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25  ^{\circ}\text{C}, I_F = 3.1  \text{A}, dI/dt = 100  \text{A}/\mu\text{s}^b$		-	1.0	2.0	μC
Forward Turn-On Time	t <sub>on</sub>	Intrinsic turn-on time is negligible (turn-on is dominated by L <sub>S</sub> and L <sub>D</sub> )				L <sub>D</sub> )	

#### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%.$

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# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

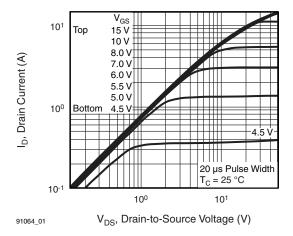


Fig. 1 - Typical Output Characteristics, T<sub>C</sub> = 25 °C

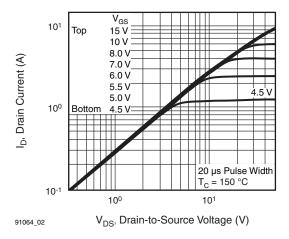


Fig. 2 - Typical Output Characteristics,  $T_C = 150 \, ^{\circ}\text{C}$ 

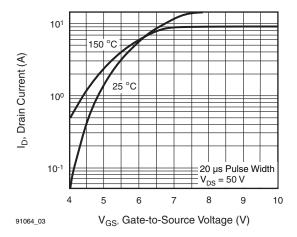


Fig. 3 - Typical Transfer Characteristics

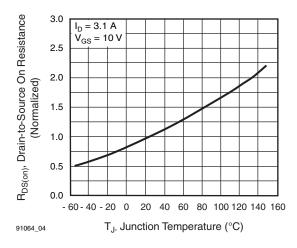


Fig. 4 - Normalized On-Resistance vs. Temperature

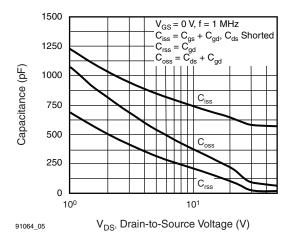


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

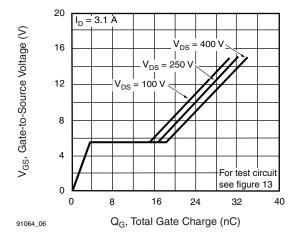


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



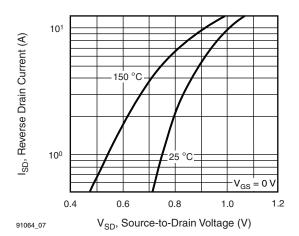


Fig. 7 - Typical Source-Drain Diode Forward Voltage

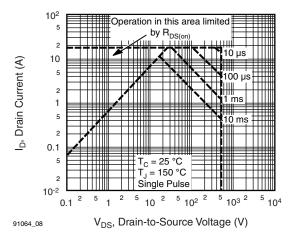


Fig. 8 - Maximum Safe Operating Area

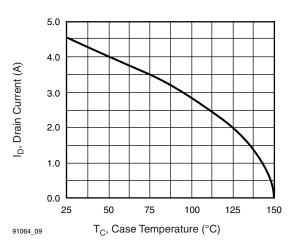


Fig. 9 - Maximum Drain Current vs. Case Temperature

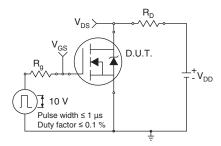


Fig. 10a - Switching Time Test Circuit

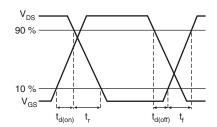


Fig. 10b - Switching Time Waveforms

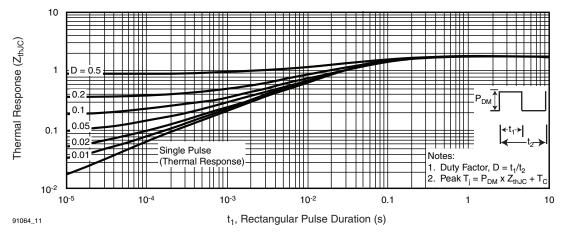


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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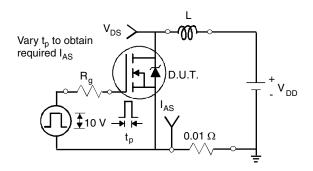


Fig. 12a - Unclamped Inductive Test Circuit

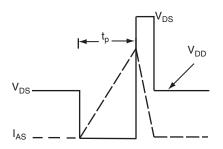


Fig. 12b - Unclamped Inductive Waveforms

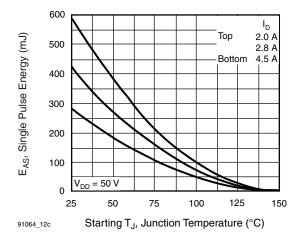


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

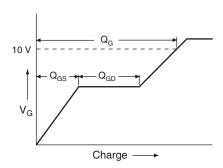


Fig. 13a - Basic Gate Charge Waveform

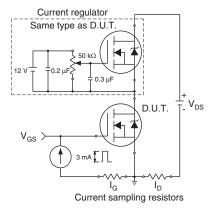
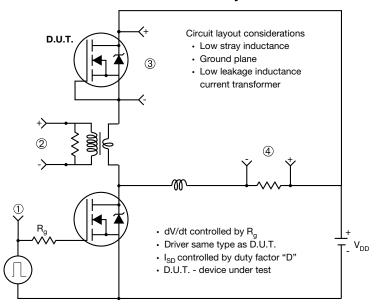


Fig. 13b - Gate Charge Test Circuit

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#### Peak Diode Recovery dV/dt Test Circuit



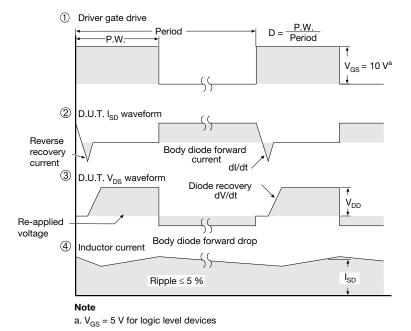


Fig. 14 - For N-Channel

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## **TO-263AB (HIGH VOLTAGE)**







]	+		D1	4
	-E1-	<b>₩</b>	<u> </u>	7

	MILLIN	METERS	INC	HES
DIM.	MIN. MAX.		MIN.	MAX.
Α	4.06	4.83	0.160	0.190
A1	0.00	0.25	0.000	0.010
b	0.51	0.99	0.020	0.039
b1	0.51	0.89	0.020	0.035
b2	1.14	1.78	0.045	0.070
b3	1.14	1.73	0.045	0.068
С	0.38	0.74	0.015	0.029
c1	0.38	0.58	0.015	0.023
c2	1.14	1.65	0.045	0.065
D	8.38	9.65	0.330	0.380

	MILLIN	METERS	INC	HES
DIM.	MIN.	MIN. MAX.		MAX.
D1	6.86	-	0.270	-
E	9.65	10.67	0.380	0.420
E1	6.22	-	0.245	i
е	2.54	BSC	0.100 BSC	
Н	14.61	15.88	0.575	0.625
L	1.78	2.79	0.070	0.110
L1	-	1.65	ı	0.066
L2	-	1.78	i	0.070
L3	0.25 BSC		0.010	BSC
L4	4.78	5.28	0.188	0.208

### DWG: 5970 Notes

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimensions are shown in millimeters (inches).

ECN: S-82110-Rev. A, 15-Sep-08

- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.
- 4. Thermal PAD contour optional within dimension E, L1, D1 and E1.
- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.

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